

Description

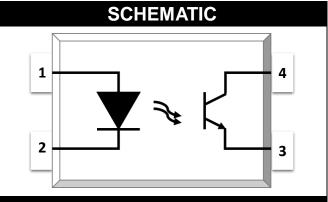
The TD851 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar high voltage phototransistor detector in a plastic DIP4 package with different lead forming options. With the robust coplanar double mold structure, TD851 series provide the most stable isolation feature.

Features

- High isolation 5000 VRMS
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898

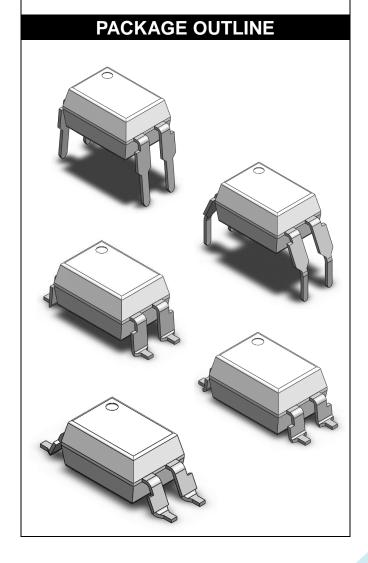
Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment



PIN DEFINITION

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector





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ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	VALUE	UNIT	NOTE		
INPUT						
Forward Current	lf	60	mA			
Peak Forward Current	IFP	1	Α	1		
Reverse Voltage	VR	6	V			
Input Power Dissipation	Pı	100	mW			
OUTPUT						
Collector - Emitter Voltage	VCEO	350	V			
Emitter - Collector Voltage	VECO	7	V			
Collector Current	Ic	50	mA			
Output Power Dissipation	Po	150	mW			
COMMON						
Total Power Dissipation	Ptot	200	mW			
Isolation Voltage	Viso	5000	Vrms	2		
Operating Temperature	Topr	-55~110	°C			
Storage Temperature	Tstg	-55~125	°C			
Soldering Temperature	Tsol	260	°C			

Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = $40 \sim 60\%$



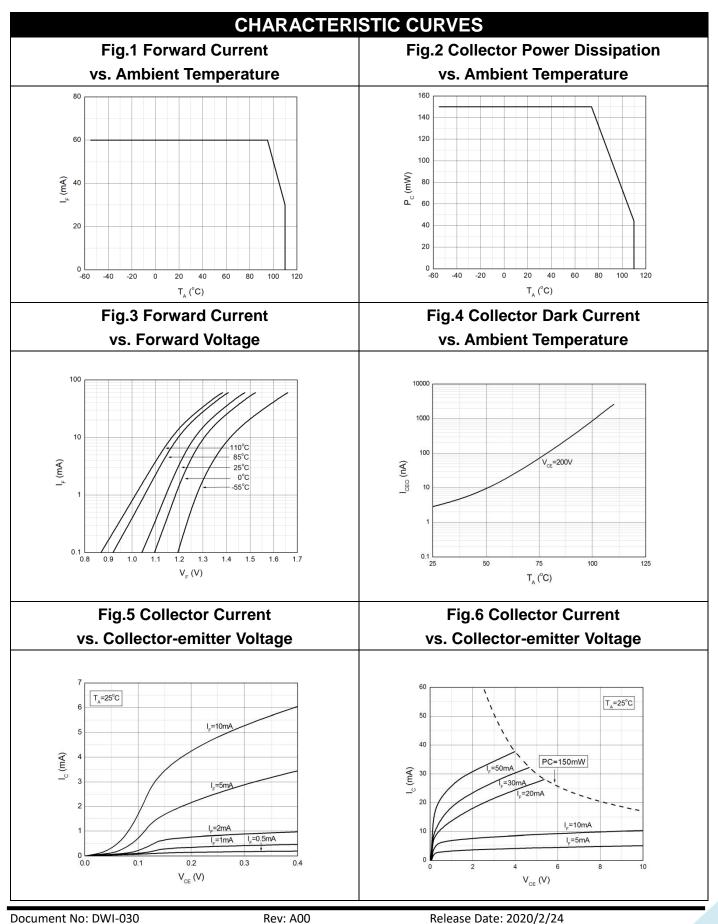
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ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C								
PARAME	TER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
	INPUT							
Forward V	oltage	VF	-	1.24	1.4	V	IF=10mA	
Reverse C	Current	I _R	-	-	10	μA	VR=6V	
Input Capa	citance	Cin	-	10	ı	pF	V=0, f=1kHz	
OUTPUT								
Collector Dar	k Current	ICEO	-	-	100	nA	VCE=200V, IF=0	
Collector-E	Emitter	BVceo	350	_		V	IC=0.1mA, IF=0	
Breakdown	Voltage	DVCEO	330	-	_	V	10-0.1111A, 11 -0	
Emitter-Co	llector	BVECO	7	_	_	V	IE=0.1mA, IF=0	
Breakdown	Voltage	DVECO	'	_	_	V	IL=0.1111A, II =0	
	TRANSFER CHARACTERISTICS							
Current								
Transfer	TD851	CTR	50	-	600	%	IF=5mA, VCE=5V	
Ratio								
Collector-E	Collector-Emitter		_	0.055	0.4	V	IF=20mA, IC=1mA	
Saturation \	Voltage	VCE(sat)	_	0.000	0.4	V	11 –2011/A, 10–111/A	
Isolation Re	sistance	Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Cap	acitance	Сю	-	0.6	1	pF	V=0, f=1MHz	
Cut-off Frequency		fc -	80	_	kHz	VCE=2V, IC=2mA	4	
		10	-	00	_	KI IZ	RL=100Ω,-3dB	7
Response Tir	me (Rise)	tr	-	3	18	μs	VCE=2V, IC=2mA	3
Response Time (Fall)		tf	-	5	18 μs RL=100Ω 3			

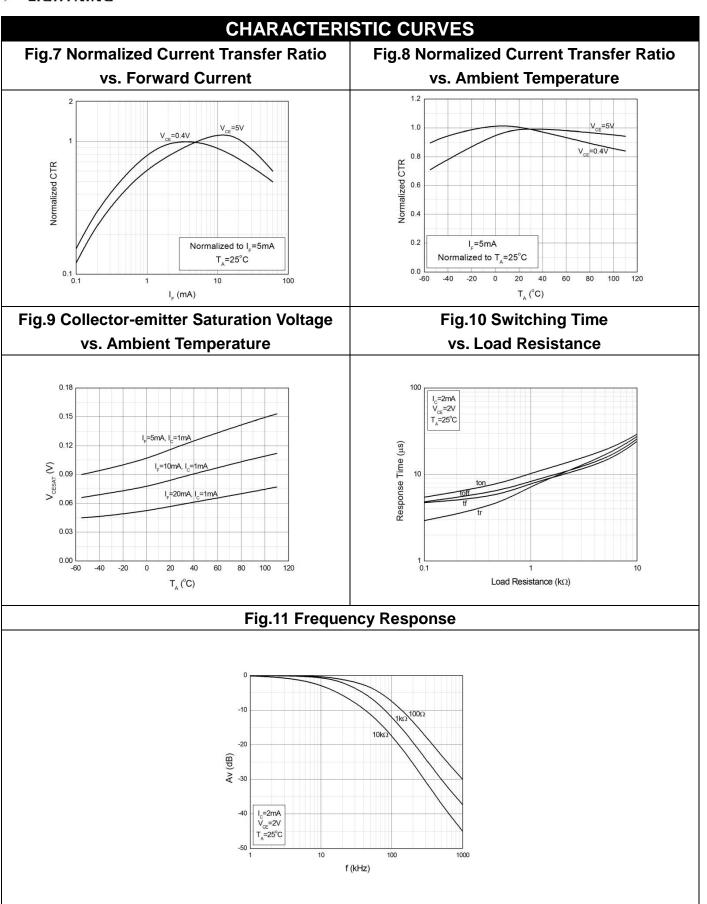
Note 3. Fig.12&13

Note 4. Fig.14

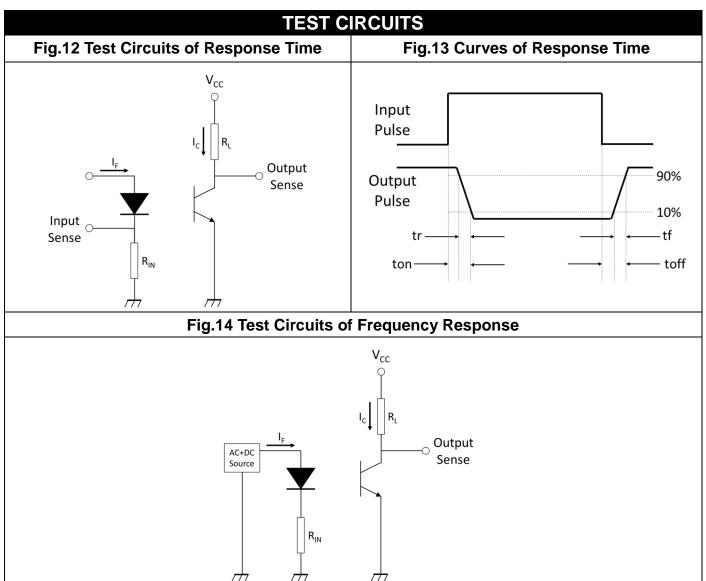




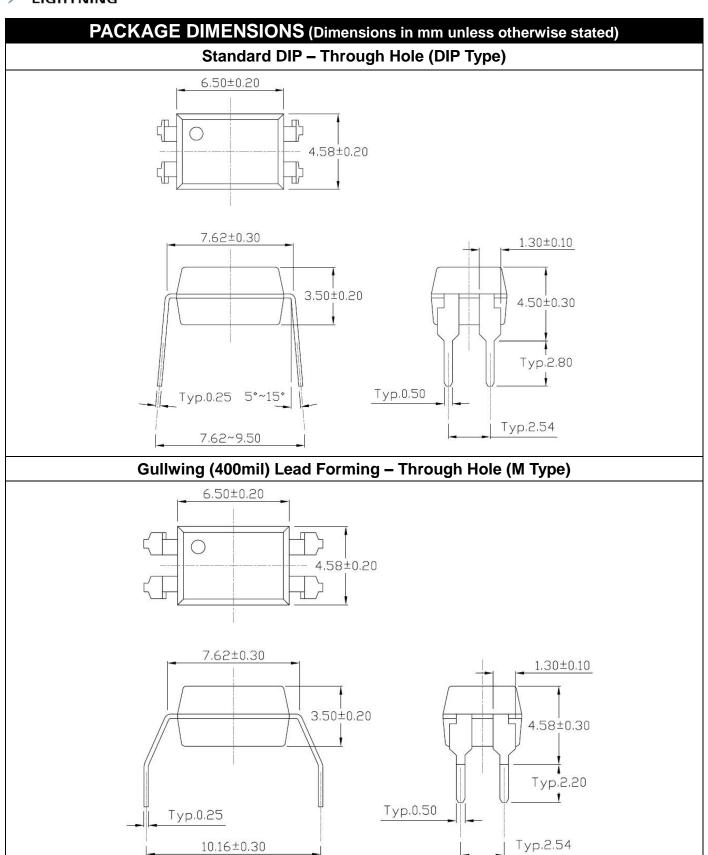




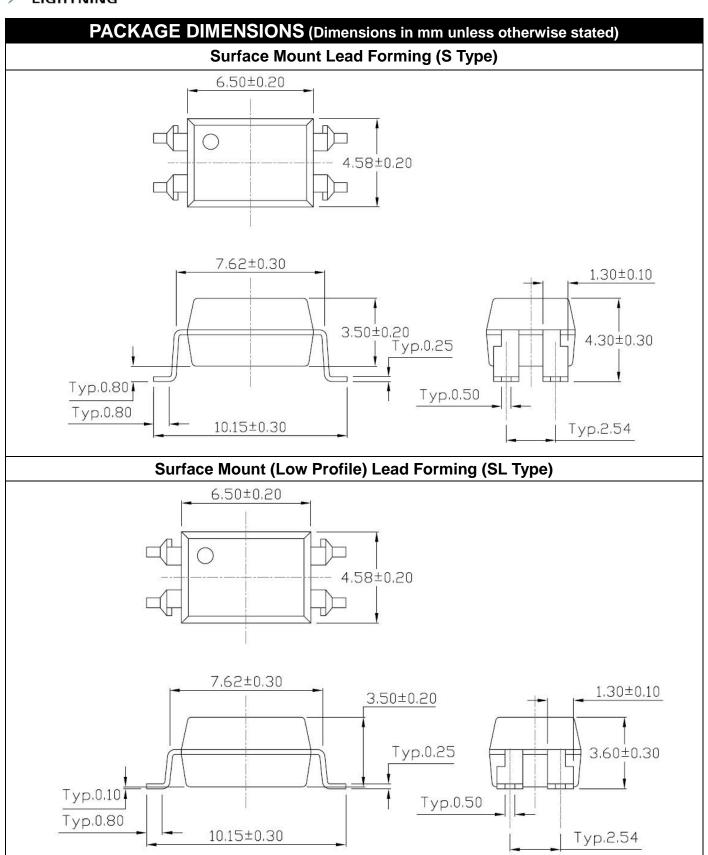








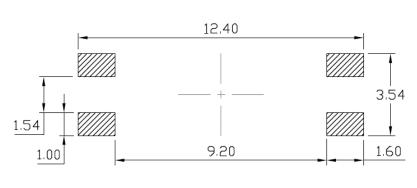




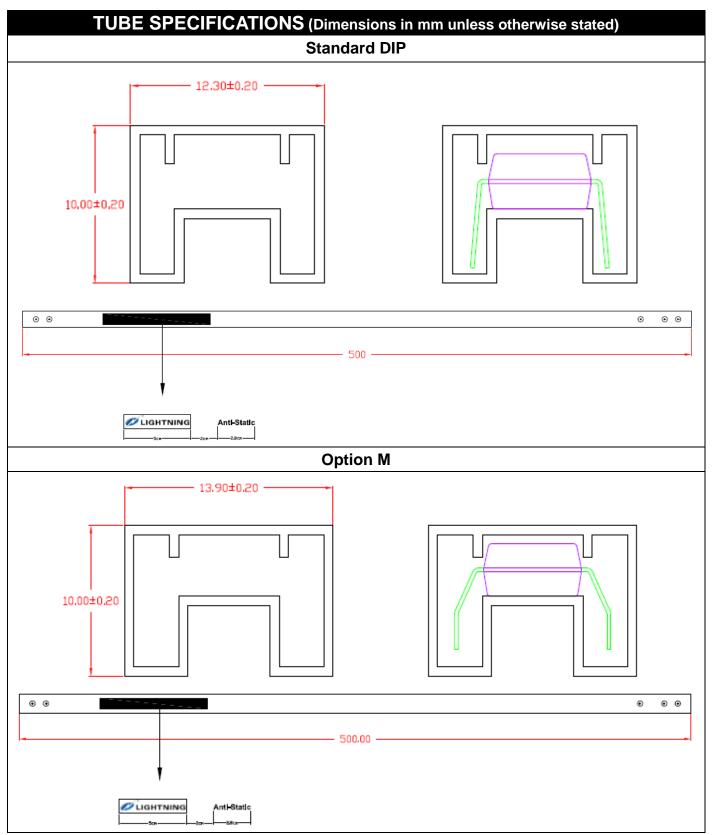


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) Surface Mount (Gullwing) Lead Forming (SLM Type) 6.50±0.20 4.58±0.20 0.40±0.10 7.62±0.30 1.30±0.10 3.50±0.20 3.75±0.30 Typ.0.25 0.25±0.20 Typ.0.50 10.16±0.30 0.60Min. Typ.2.54 11.80±0.30 RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated) Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming 10.75 3,54 1.54 7,55

Surface Mount (Gullwing) Lead Forming

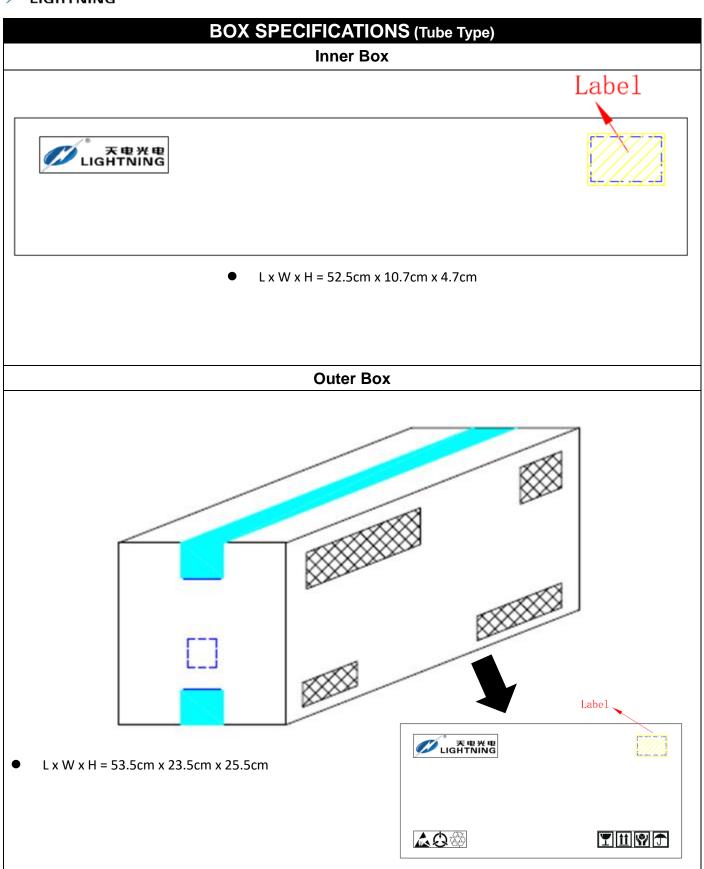






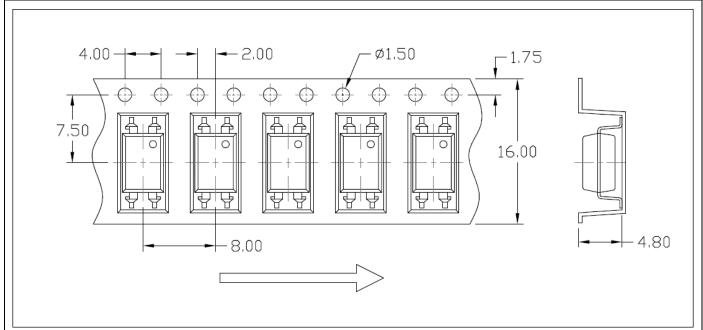


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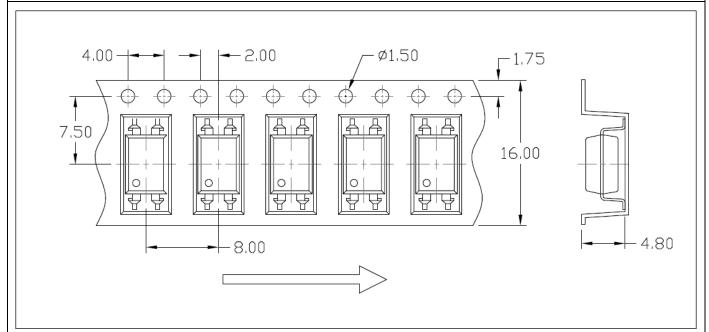




CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated) Option S(T1) & SL(T1)



Option S(T2) & SL(T2)



4.80

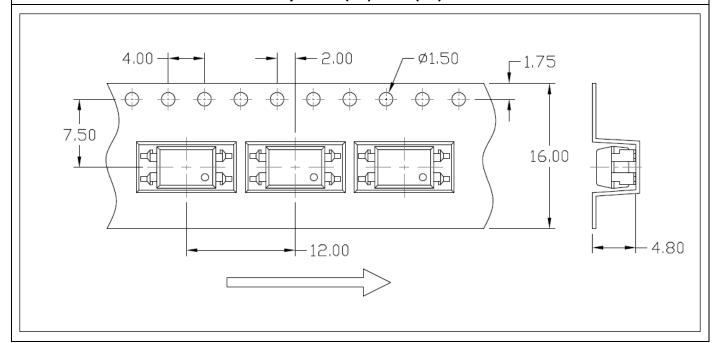


DIP4, DC Input, High Voltage Photo Transistor Coupler

CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated) Option S(T3) & SL(T3)

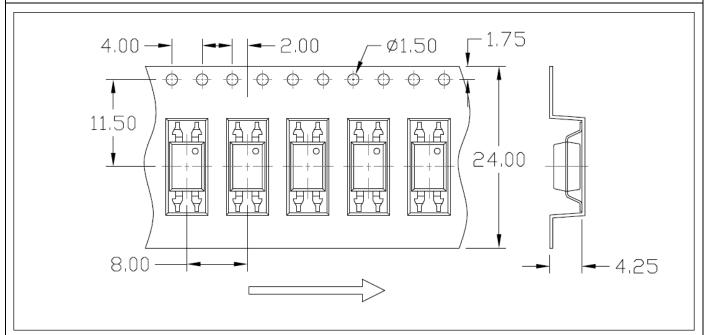
Option S(T4) & SL(T4)

-12.00

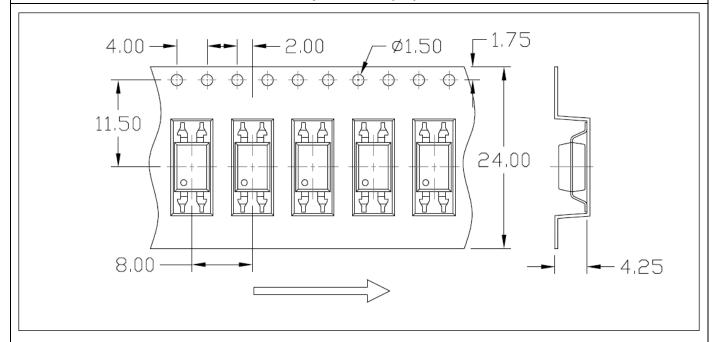




CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated) **Option SLM(T1)**

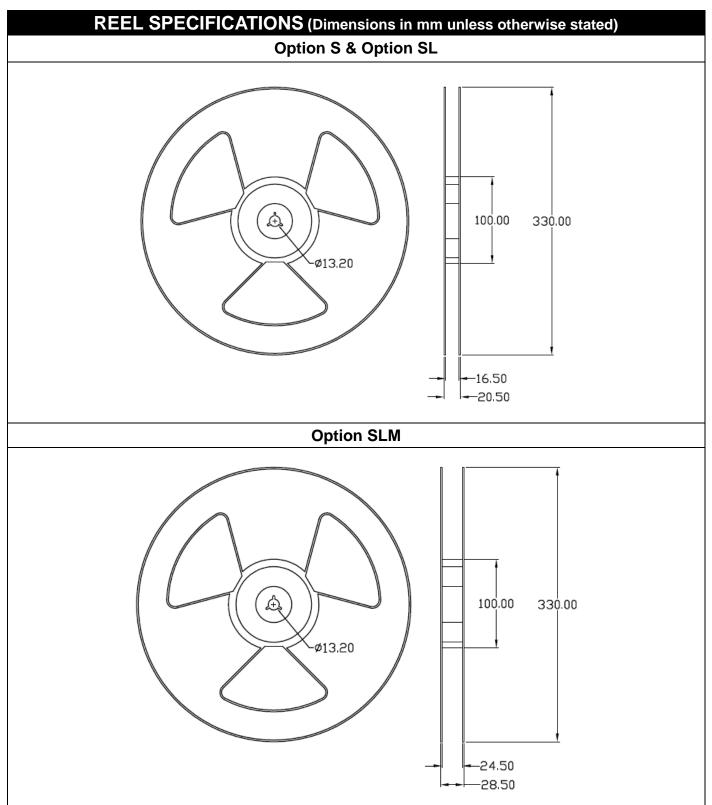


Option SLM(T2)



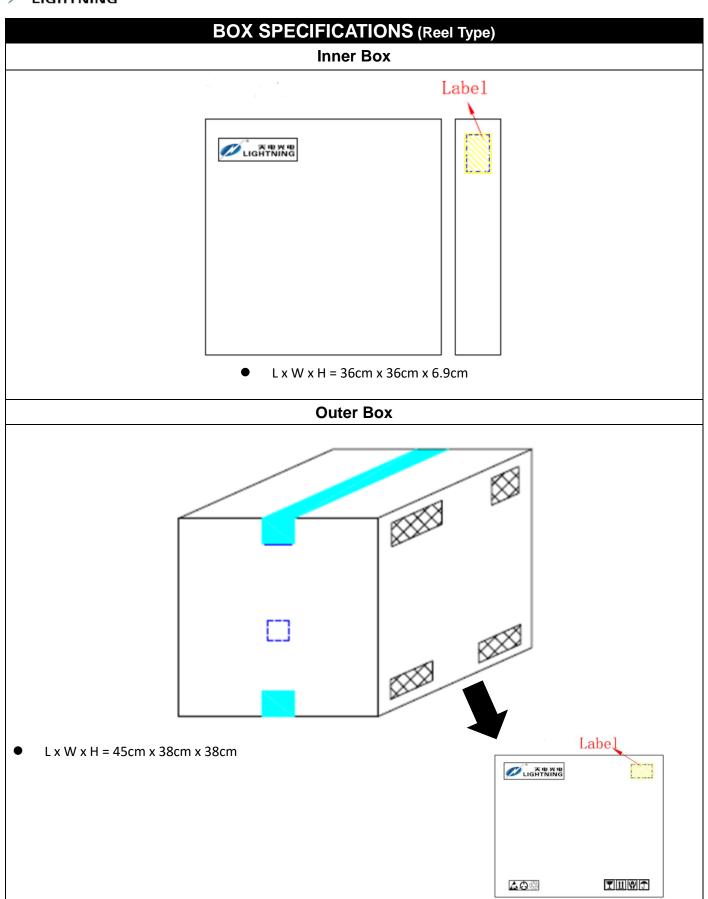


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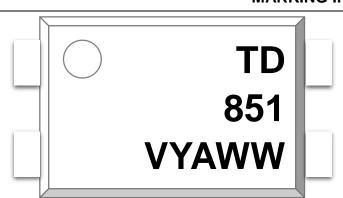
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ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr.

851 : Part Number

X : CTR Rank

V : VDE Option

: Fiscal Year

: Manufacturing Code

ww : Work Week

ORDERING INFORMATION

TD851(Y)(Z)-GV

TD – Company Abbr.

851 - Part Number

Y – Lead Form Option (M/S/SL/SLM/None)

Z - Tape and Reel Option (T1/T2/T3/T4)

G - Green

V – VDE Option (V or None)

LABEL INFORMATION



Part No: XXXXXXXXXXXXXX Bin Code: X

Lot No: XXXXXXXXXX

Date Code: XXXX Q'ty: XXXX pcs





Packing Quantity

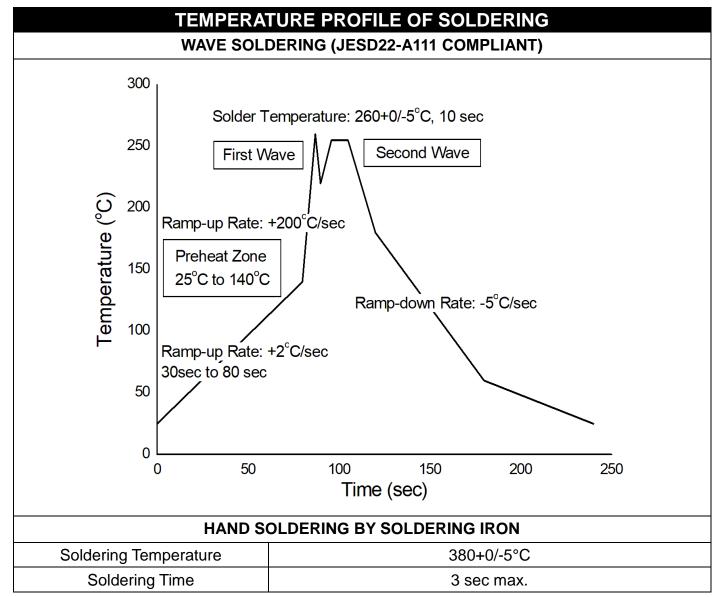
Option	Quantity	Quantity - Inner box	Quantity – Outer box	
None	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units	
М	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units	
S(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
S(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
S(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
S(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SL(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
SL(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
SL(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SL(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SLM(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
SLM(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	



REFLOW INFORMATION REFLOW PROFILE Supplier T_p ≥ T_c User $T_p \le T_c$ T_{c} T_C -5°C Supplier tp T_p T_c -5°C Max. Ramp Up Rate = 3°C/s Max. Ramp Down Rate = 6°C/s Temperature T_L T_{smax} Preheat Area T_{smin} 25 Time 25°C to Peak IPC-020d-5-1

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary
 over time. All operating parameters, including typical parameters, must be validated in each
 customer application by the customer's technical experts. Product specifications do not expand or
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 warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.